

# QUICKSWITCH® PRODUCTS 2.5V/ IDTQS3VH16861 3.3V 20-BIT FLOW-THROUGH PIN OUT, HIGH BANDWIDTH BUS SWITCH

#### **FEATURES:**

- · N channel FET switches with no parasitic diode to Vcc
  - Isolation under power-off conditions
  - No DC path to Vcc or GND
  - 5V tolerant in OFF and ON state
- 5V tolerant I/Os
- Low Ron  $4\Omega$  typical
- · Flat Ron characteristics over operating range
- Rail-to-rail switching 0 5V
- Bidirectional dataflow with near-zero delay: no added ground bounce
- . Excellent Ron matching between channels
- · Vcc operation: 2.3V to 3.6V
- · High bandwidth up to 500 MHz
- · LVTTL-compatible control Inputs
- · Undershoot Clamp Diodes on all switch and control Inputs
- · Low I/O capacitance, 4pF typical
- · Available in TSSOP package

### **APPLICATIONS:**

- · Hot-swapping
- 10/100 Base-T, Ethernet LAN switch
- · Low distortion analog switch
- · Replaces mechanical relay
- ATM 25/155 switching

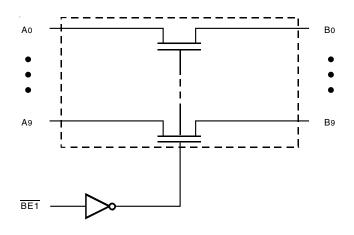
#### **DESCRIPTION:**

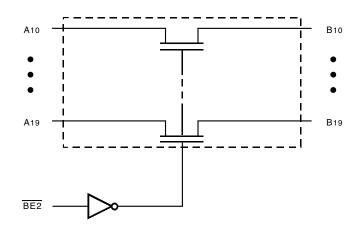
The QS3VH16861 HotSwitch with 20-bit flow-though pin out is a high bandwidth bus switch. The QS3VH16861 has very low ON resistance, resulting in under 250ps propagation delay through the switch. The switches are controlled by active low enable ( $\overline{\text{BEx}}$ ) controls. In the ON state, the switches can pass signals up to 5V. In the OFF state, the switches offer very high impedence at the terminals.

The combination of near-zero propagation delay, high OFF impedance, and over-voltage tolerance makes the QS3VH16861 ideal for high performance communications applications.

The QS3VH16861 is characterized for operation from -40°C to +85°C.

## **FUNCTIONAL BLOCK DIAGRAM**





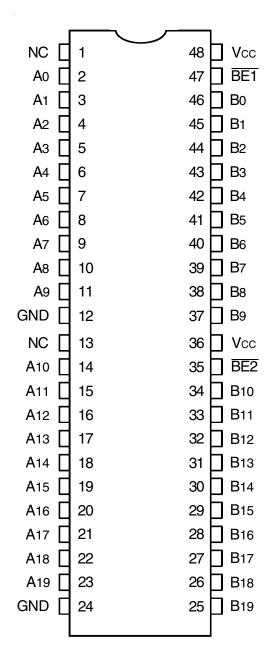
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INDUSTRIAL TEMPERATURE RANGE

**JUNE 2013** 

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## **PIN CONFIGURATION**



TSSOP TOP VIEW

## **ABSOLUTE MAXIMUM RATINGS**(1)

Symbol	Description	Max.	Unit
VTERM(2)	Supply Voltage to Ground	-0.5 to 4.6	V
VTERM(3)	DC Switch Voltage Vs	-0.5 to 5.5	V
VTERM(3)	DC Input Voltage VIN	- 0.5 to 5.5	V
VAC	AC Input Voltage (pulse width ≤20ns)	-3	V
lout	DC Output Current (max. current/pin)	120	mA
Tstg	Storage Temperature	-65 to +150	°C

#### NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may
  cause permanent damage to the device. This is a stress rating only and functional
  operation of the device at these or any other conditions above those indicated in the
  operational sections of this specification is not implied. Exposure to absolute
  maximum rating conditions for extended periods may affect reliability.
- 2. Vcc terminals.
- 3. All terminals except Vcc.

## **CAPACITANCE** (TA = +25°C, f = 1MHz, VIN = 0V, VOUT = 0V)

Symbol	Parameter <sup>(1)</sup>	Тур.	Max.	Unit
CIN	Control Inputs	3	5	pF
CI/O	Quickswitch Channels (Switch OFF)	4	6	pF
CI/O	Quickswitch Channels (Switch ON)	8	12	pF

#### NOTE:

1. This parameter is guaranteed but not production tested.

### **PIN DESCRIPTION**

Pin Names	Description
BEx	Active LOW Bus Enable
A0 - A19	Bus A
B 0 - B19	Bus B

## **FUNCTION TABLE**(1)

Ē	BE <sub>1</sub>	BE <sub>2</sub>	A0 - A9	A10 - A19	Function
	L	L	B0 - B9	B10 - B19	Connect
	L	Н	B0 - B9	Z	Connect Bo - B9,
					Disconnect B10 - B19
	Н	L	Z	B10 - B19	Disconnect Bo - B9,
					Connect B10 - B19
	Н	Н	Z	Z	Disconnect

### NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

Z = High-Impedence

# DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE(1)

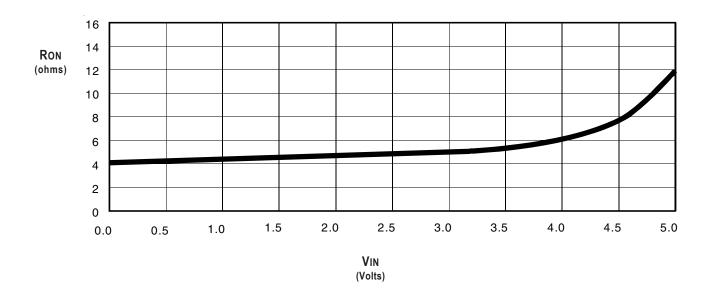
 $Following\ Conditions\ Apply\ Unless\ Otherwise\ Specified:$ 

Industrial: TA = -40°C to +85°C, VCC = 3.3V  $\pm 0.3$ V

Symbol	Parameter	Test Conditions			Min.	Typ. <sup>(1)</sup>	Max.	Unit
VIH	Input HIGH Voltage	Guaranteed Logic HI	GH	Vcc = 2.3V to 2.7V	1.7	_	_	V
		for Control Inputs		Vcc = 2.7V to 3.6V	2	_	_	
VIL	Input LOW Voltage	Guaranteed Logic HIGH Vcc = 2.3V to 2.7V		_	_	0.7	V	
		for Control Inputs Vcc = 2.7V to 3.6V		_	_	0.8		
lin	Input Leakage Current (Control Inputs)	0V ≤ Vin ≤ Vcc		_	_	±1	μA	
loz	Off-State Current (Hi-Z)	0V ≤ Vouт ≤ 5V, Switches OFF		_	_	±1	μA	
loff	Data Input/Output Power Off Leakage	VIN or VOUT 0V to 5\	/, Vcc = 0V		_	_	±1	μA
		Vcc = 2.3V	VIN = 0V	Ion = 30mA	_	6	8	
Ron	Switch ON Resistance	(Typ. at Vcc = 2.5V)	VIN = 1.7V	Ion = 15mA	_	7	9	Ω
		Vcc = 3V	VIN = 0V	Ion = 30mA		4	6	
			VIN = 2.4V	ION = 15mA	_	5	8	

#### NOTE:

## TYPICAL ON RESISTANCE vs Vin AT Vcc = 3.3V



<sup>1.</sup> Typical values are at Vcc = 3.3V and TA = 25°C, unless otherwise noted.

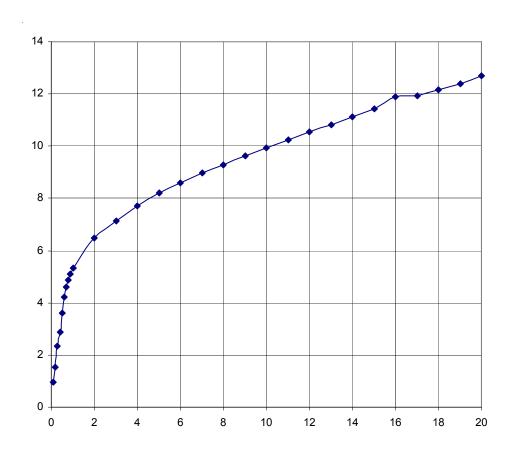
## **POWER SUPPLY CHARACTERISTICS**

Symbol	Parameter	Test Conditions <sup>(1)</sup>	Min.	Тур.	Max.	Unit
Iccq	Quiescent Power Supply Current	Vcc = Max., Vin = GND or Vcc, f = 0	_	1.5	3	mA
Δlcc	Power Supply Current <sup>(2,3)</sup> per Input HIGH	Vcc = Max., Vin = 3V, f = 0 per Control Input	_	_	30	μΑ
ICCD	Dynamic Power Supply Current <sup>(4)</sup> Vcc = 3.3V, A and B Pins Open, Control Inputs		See Typical	CCD vs Enable	Frequency gra	ph below
		Toggling @ 50% Duty Cycle				

#### NOTES:

- 1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.
- 2. Per input driven at the specified level. A and B pins do not contribute to Δlcc.
- 3. This parameter is guaranteed but not tested.
- 4. This parameter represents the current required to switch internal capacitance at the specified frequency. The A and B inputs do not contribute to the Dynamic Power Supply Current. This parameter is guaranteed but not production tested.

## TYPICAL ICCD vs ENABLE FREQUENCY CURVE AT Vcc = 3.3V



**ENABLE FREQUENCY (MHz)** 

## SWITCHING CHARACTERISTICS OVER OPERATING RANGE

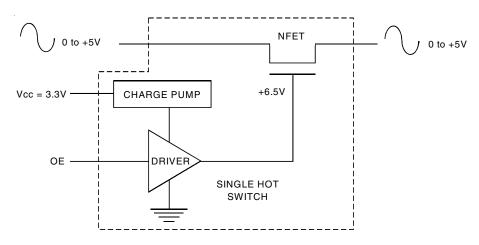
 $T_A = -40$ °C to +85°C

		$Vcc = 2.5 \pm 0.2V^{(1)}$		$Vcc = 3.3 \pm 0.3 V^{(1)}$		
Symbol	Parameter	Min. <sup>(4)</sup>	Max.	Min. <sup>(4)</sup>	Max.	Unit
<b>t</b> PLH	Data Propagation Delay <sup>(2,3)</sup>		0.2		0.2	ns
<b>t</b> PHL	A to B or B to A					
tpzh	Switch Turn-On Delay	1.5	8.5	1.5	8	ns
tPZL	BEx to xA or xB					
tPHZ	Switch Turn-Off Delay	1.5	7.5	1.5	7.5	ns
tPLZ	BEx to xA or xB					
fBEx	Operating Frequency - Enable (2,5)		10		20	MHz

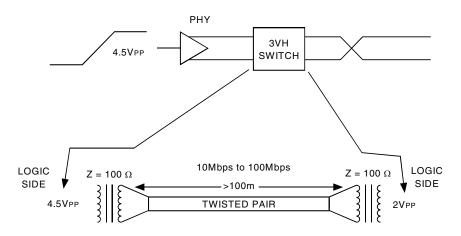
#### NOTES:

- 1. See Test Conditions under TEST CIRCUITS AND WAVEFORMS.
- 2. This parameter is guaranteed but not production tested.
- 3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.2ns at C<sub>L</sub> = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.
- 4. Minimums are guaranteed but not production tested.
- 5. Maximum toggle frequency for  $\overline{BEx}$  control input (pass voltage > Vcc, Vin = 5V, RLOAD  $\geq$  1M $\Omega$ , no CLOAD).

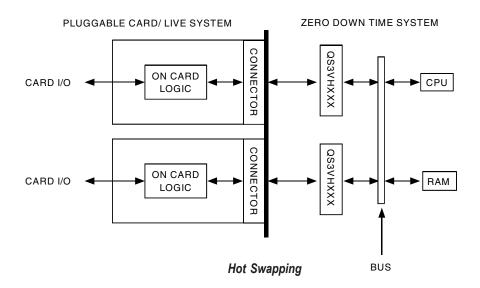
## SOME APPLICATIONS FOR HOTSWITCH PRODUCTS



Rail-to-Rail Switching



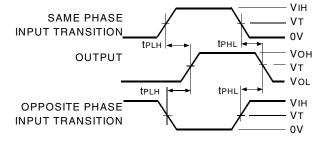
Fast Ethernet Data Switching (LAN Switch)



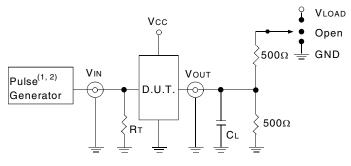
## **TEST CIRCUITS AND WAVEFORMS**

## **TEST CONDITIONS**

Symbol	Vcc <sup>(1)</sup> = 3.3V ± 0.3V	Vcc <sup>(2)</sup> = 2.5V ± 0.2V	Unit
VLOAD	6	2 x Vcc	V
VIH	3	Vcc	V
VT	1.5	Vcc/2	V
VLZ	300	150	mV
VHZ	300	150	mV
CL	50	30	pF



**Propagation Delay** 



Test Circuits for All Outputs

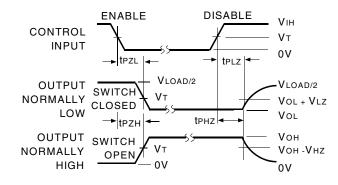
#### DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZouT of the Pulse Generator.

#### NOTES:

- 1. Pulse Generator for All Pulses: Rate  $\leq$  1.0MHz; tr  $\leq$  2.5ns; tr  $\leq$  2.5ns.
- 2. Pulse Generator for All Pulses: Rate  $\leq$  1.0MHz; tF  $\leq$  2ns; tR  $\leq$  2ns.



### NOTE:

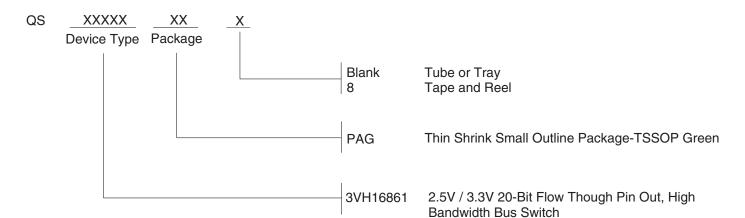
1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

### **Enable and Disable Times**

### **SWITCH POSITION**

Test	Switch
tplz/tpzl	VLOAD
tpHz/tpzH	GND
tPD	Open

# **ORDERING INFORMATION**



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TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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